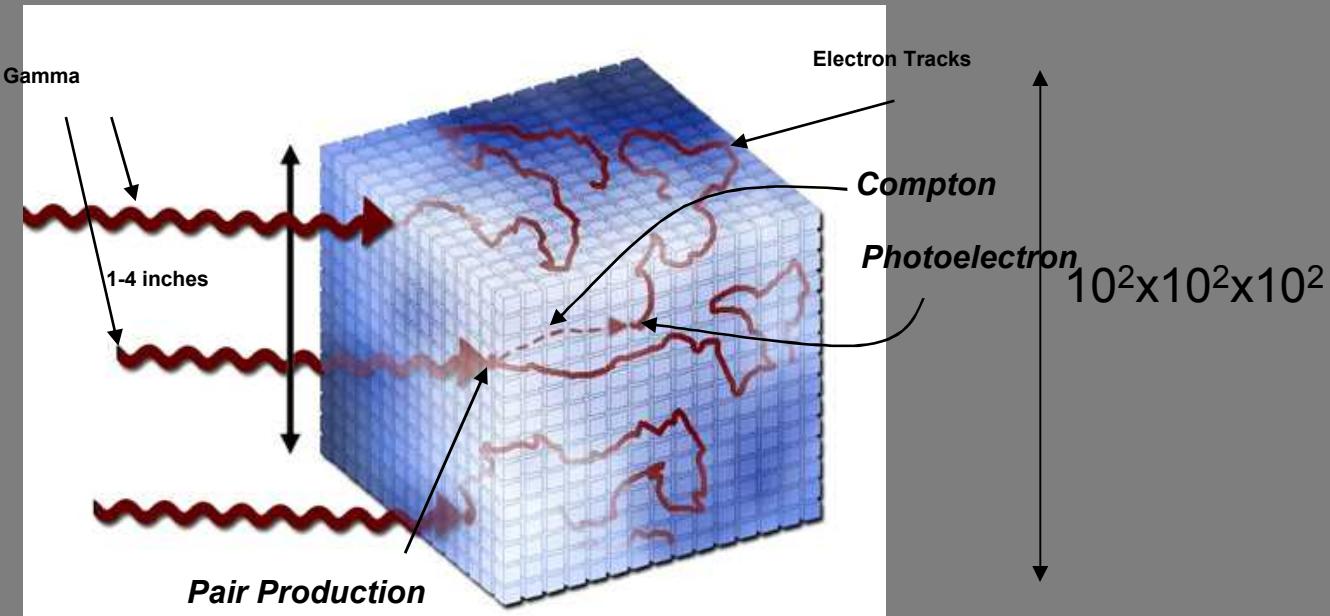


# Improved Gamma Sensors – Getting more info out of the radiation field

Orders of Magnitude  
Faster ID and  
location of material



DARPA Industry Day Sponsored by D. Shenoy, Santa Cruz, Ca, July 17, 2009

PI: Mark Derzon. SNL. Contributors: R. Anderson, G. Chandler, M. Cich, L. Claus, D. Derzon, M.S. Derzon, P. Galambos, M. Grohman, H. Hjalvarson, R. Jarecki, R. Kay, R. Kensek, T. Lemp, Shawn Martin, K. Ortiz, T. Parson, R. Renzi, K. Seager, S. Shinde, D. Trotter, 7/17/09

... specifically outlining the state of the art for the technology and metrics of a potential program

- Historical Analysis
- Competitive analysis?
- Gap Analysis?
- Impact analysis?
- Structure a BAA?



Problem  
(gap analysis)  
Proposed Solution  
Benefit

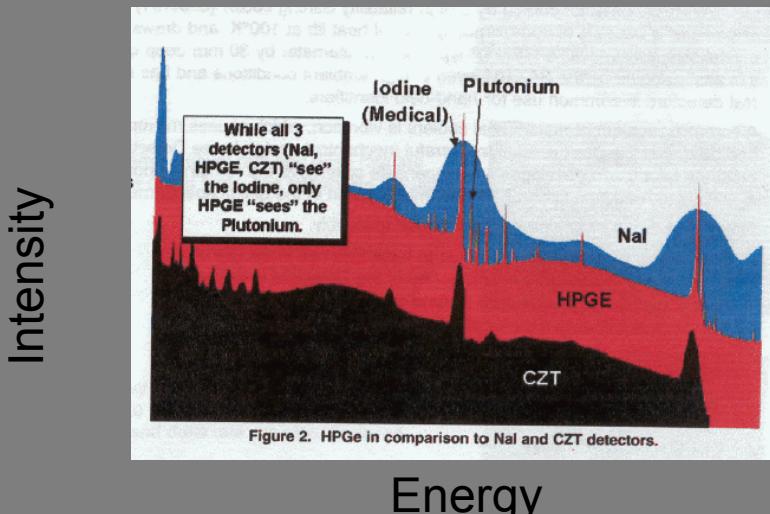
# State-of-Art

- Scintillators (NaI, plastic)
- Solid State (Ge, CdZnTe, etc.)
- Calorimeters (LANL/LLNL groups)

## Phase Space

Limitations (efficiency, resolution, timing, cost)

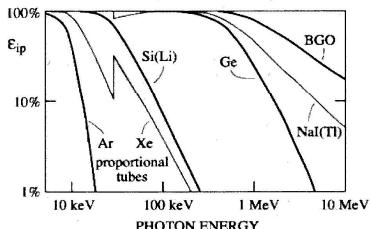
Volume, Z,  
-.1% - 7% resolution  
ns to 100-microsec  
500\$/unit to 50k\$/unit  
Cooled to room temp



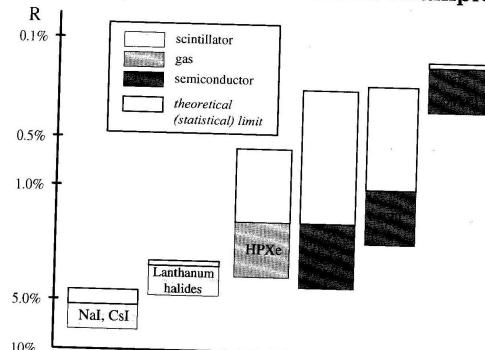
# G. Knoll created some 'comparative' relationships

SU7

## X- and Gamma Ray Intrinsic Peak Efficiency



## Energy Resolution - Some Examples

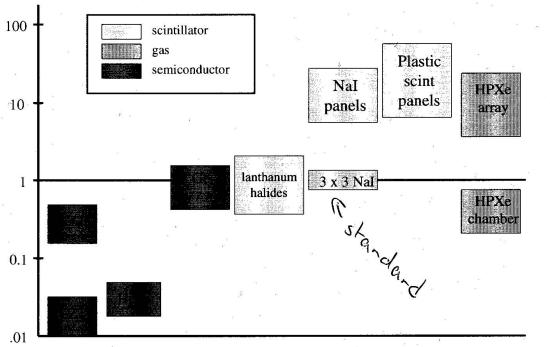


## Timing Characteristics

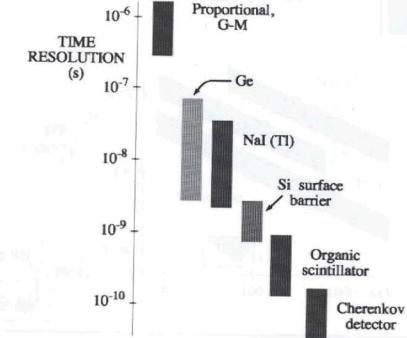
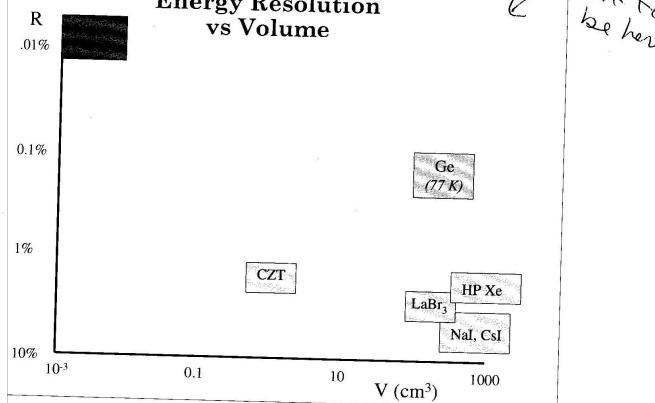
- Charge collection time in detector sets lower limit on pulse rise time
- Preamplifier and capacitive loading of detector may slow the observed rise time from fast detectors
- Variations in pulse shape may lead to additional timing uncertainties
- Timing jitter due to discreteness of charge carriers is minimized in detectors with large number of carriers

SU8

## Gamma-Ray Counting Sensitivity (typical sizes)



## Energy Resolution vs Volume



Gaps: too inefficient or poor resolution or to small or slow, or expensive, or to hard to use

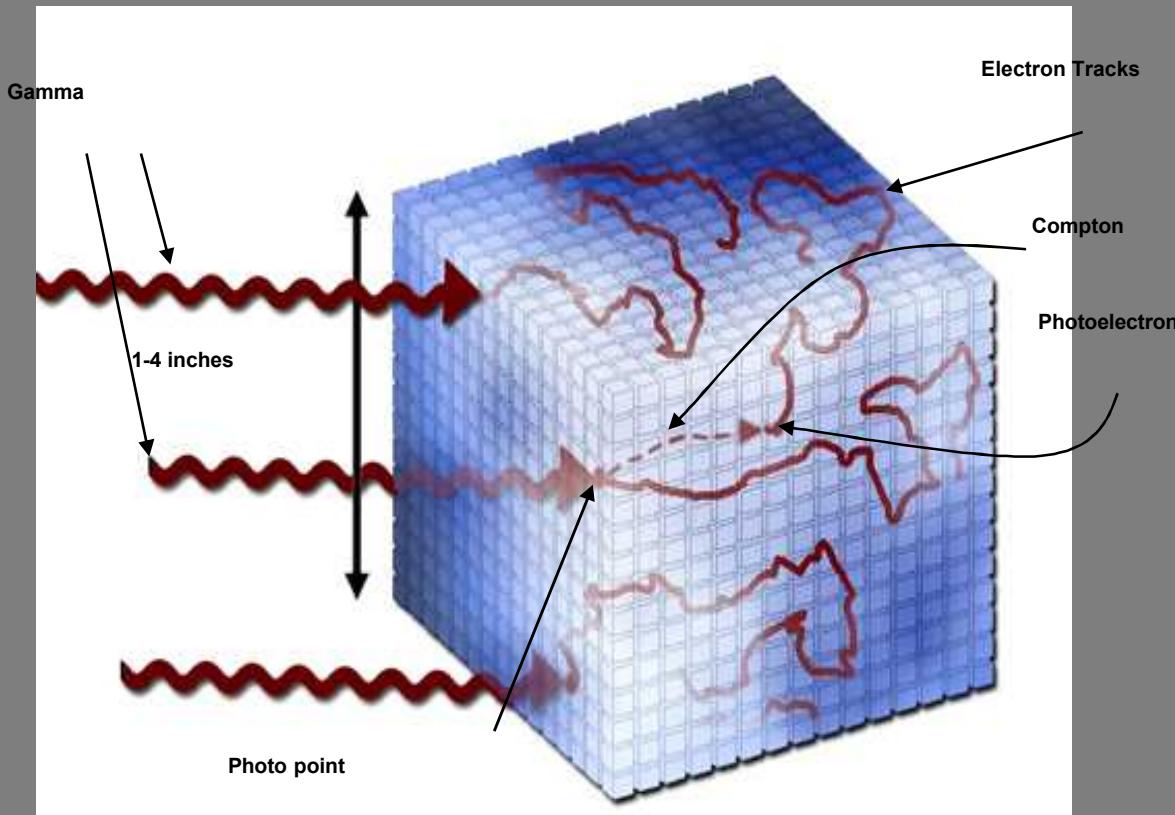
# Community Direction

- Better Materials
- Improved anode/cathode design
- New Designs –GEMs, vertex, Silicon drift, Calorimeters, pixel detectors (e.g. Zhong He, et al, at Michigan), straw tubes

## General Trend

- More information from the radiation field

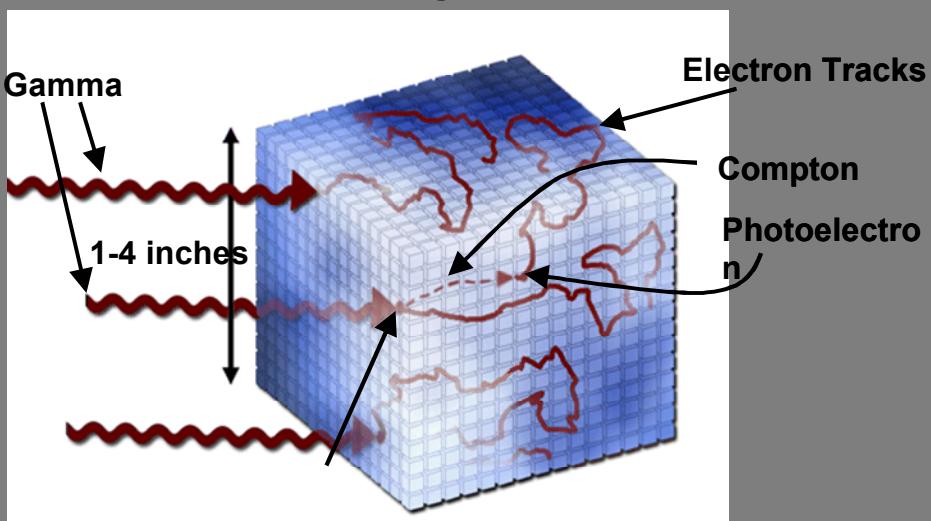
# The gap analysis – High Z and high resolution and large total volume and easy to use



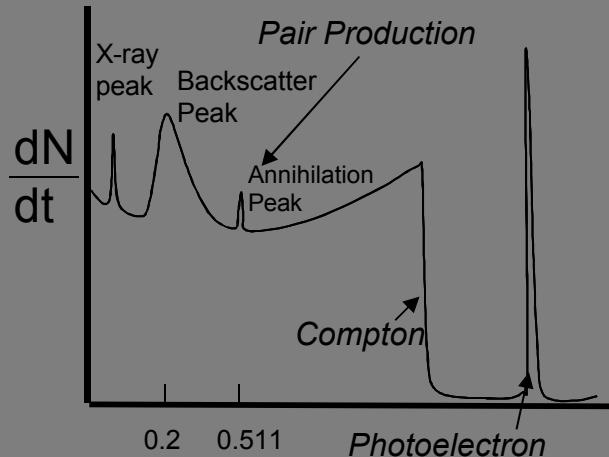
leads to this proposed solution – massively pixellated and macroscale integrated 3D systems

# Gather more info from the incident radiation field? Improved Identification/understanding of a Source

- 3D Microsystem

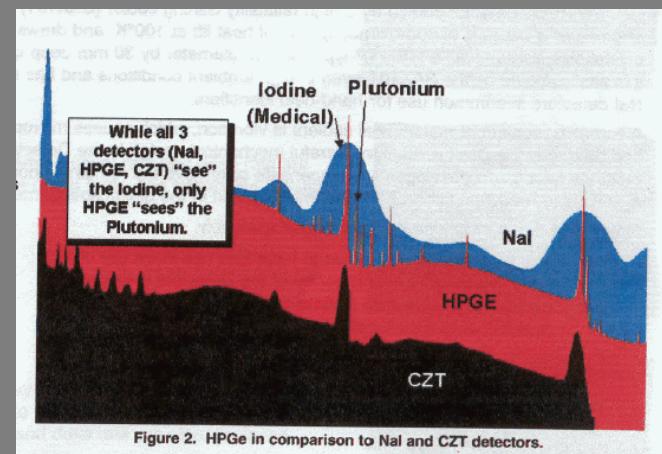


- Physics



Gamma Interactions

Intensity

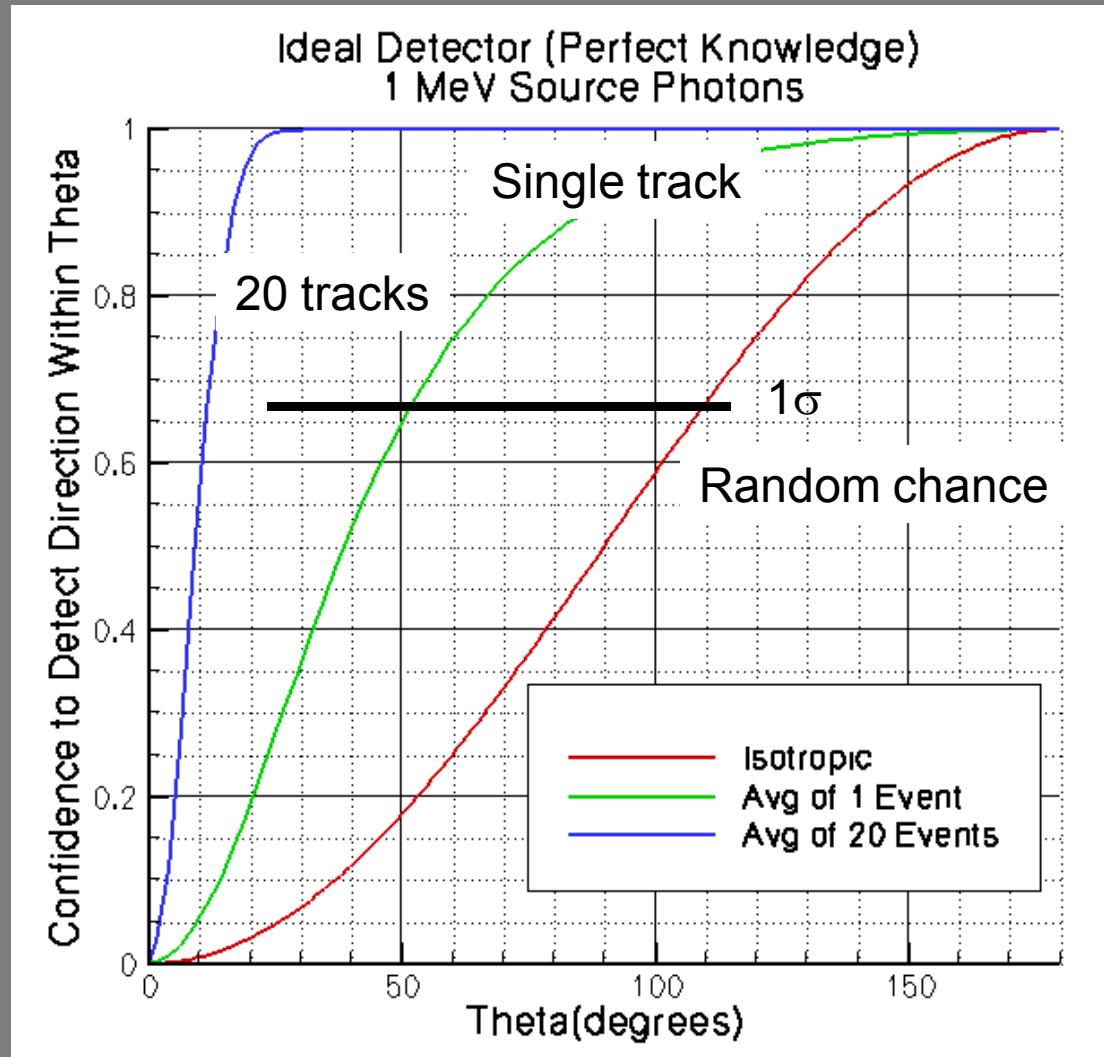


Energy

Figure 2. HPGe in comparison to NaI and CZT detectors.

# Why? Potentially orders of magnitude improvement over existing methods in *finding a source*

ITS  
Model



These lines are the Integrals of the confidence density function in theta.

They represent the probability that the real source is within theta of the inferred direction.

Gamma

# Key Technical Challenges

## • Material Science

- Grow/Deposit/fabricate detector material
- High Z $\geq$ Ge
- >80% charge collection
- >95% yield over 3cmx3cm square; target 6" wafer
- Incorporate discrete electrodes (electronic interface)
- Material Alternatives:
  - CZT
  - GaAs
  - Germanium
  - TlBr
  - Si
- Depletion Depth $>200\mu\text{m}$ @room temp  
 $200\mu\text{m}$  min.,  $600\mu\text{m}$  target

## • Packaging

- 64-296 layers
- 3cm x 3 cm $\rightarrow$  6" diameter
- Interconnects
- Flatness
- Thermal Expansion
- Inactive volume

## Electronics

- Data rate
- Track Processing
- Scaling (voxel count, rate, etc.)
- In-situ signal processing
- Architecture

## Algorithm Development

- Tracking
- Unfolding the track back to source (inverse problem)
- Background Projection
- Thresholding
- Compton Coincidence Identification

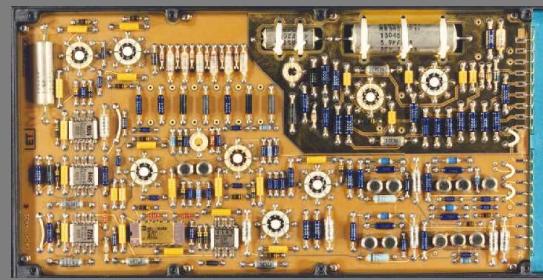
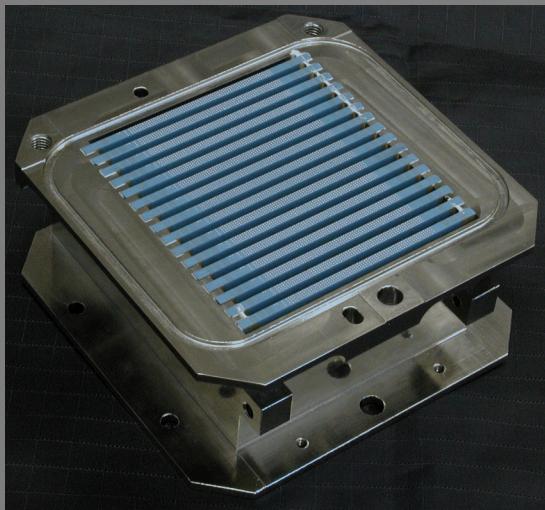
## System Scaling Studies

- System Perf. Modeling
- System Optimization

**Lots of work (though not considered tech challenge): *Integration***

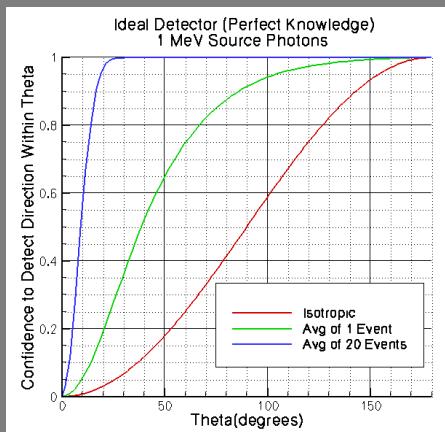
***Microsystems Technology can meet these Needs***

We believe it is possible but will be Very Difficult.



The 5 cubic inch assembly (bottom) replaced 4096 PWBs resulting in a 2000X reduction in weight & volume and a 1000X reduction in power for this mission.

Images and analysis supplied by C. Sumpter, SNL, Organization 1700.



We believe we can create  
the team ...



# Typical Scientist or Engineers Dilemma

Mission	Time To find	Time to identify	Size	Power	Cost	Confidence
	Efficiency	Resolution	Data Rate	Volume	Temp	Size
SNM						
Active Detection						
Counterproliferation/non-pro						
Nuclear Power						
Nuke Forensics						
Astrophysics						
High Energy Physics						

User  Engineer

# User Benefits and Needs

Discussing the 'more info' leads into a limitations and a gap analysis discussion

- Time-to-detect/identify
- Spectral Resolution (expected to be equivalent to todays HPGe materials)
- Cost/Performance
- Ergonomic
  - Smaller footprint (no cryogenics, no aperture, less volume)
  - Lower power requirements
- Confidence
- Background Subtraction
- Sensitivity
- Aperture-less